

SO642

SMALL SIGNAL NPN TRANSISTOR

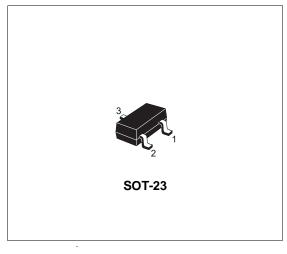
PRELIMINARY DATA

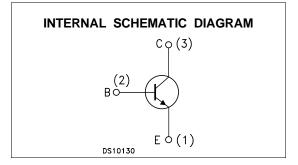
Туре	Marking
SO642	N91

- SILICON EPITAXIAL PLANAR NPN HIGH VOLTAGE TRANSISTOR
- MINIATURE SOT-23 PLASTIC PACKAGE FOR SURFACE MOUNTING CIRCUITS
- TAPE AND REEL PACKING
- THE PNP COMPLEMENTARY TYPE IS SO692

APPLICATIONS

- VIDEO AMPLIFIER CIRCUITS (RGB CATHODE CURRENT CONTROL)
- TELEPHONE WIRELINE INTERFACE (HOOK SWITCHES, DIALER CIRCUITS)





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{СВО}	Collector-Base Voltage (I _E = 0)	300	V
Vceo	Collector-Emitter Voltage (I _B = 0)	300	V
V _{EBO}	Emitter-Base Voltage $(I_C = 0)$	6	
lc	Collector Current	0.1	А
ICM	Collector Peak Current	0.3	A
Ptot	Total Dissipation at $T_C = 25 \ ^{\circ}C$	310	mW
T _{stg}	Storage Temperature	-65 to 150	°C
Тj	Max. Operating Junction Temperature	150	°C

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THERMAL DATA

R _{thj-amb} •	Thermal Resistance Junction-Ambient	Max	403.2	°C/W
Device mour	nted on a PCB area of 1 cm ²			

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \ ^{o}C$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{СВО}	Collector Cut-off Current (I _E = 0)	V _{CB} = 200 V			100	nA
V _{(BR)CBO}	Collector-Emitter Breakdown Voltage (I _E = 0)	I _C = 100 μA	300			V
$V_{(BR)CEO^*}$	Collector-Emitter Breakdown Voltage (I _B = 0)	I _C = 1 mA	300			V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage (I _C = 0)	I _E = 100 μA	6			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	$I_C = 20 \text{ mA}$ $I_B = 2 \text{ mA}$			0.5	V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	$I_C = 20 \text{ mA}$ $I_B = 2 \text{ mA}$			0.9	V
h _{FE} *	DC Current Gain		25 40 40			
f⊤	Transition Frequency	Ic = 10 mA Vce = 20 V f = 20 MHz	50			MHz
Ссво	Collector-Base Capacitance	I _E = 0 V _{CB} = 10 V f = 1MHz		6		pF
C_{EBO}	Emitter-Base Capacitance	$I_{C} = 0$ $V_{EB} = 2 V f = 1MHz$		22		pF

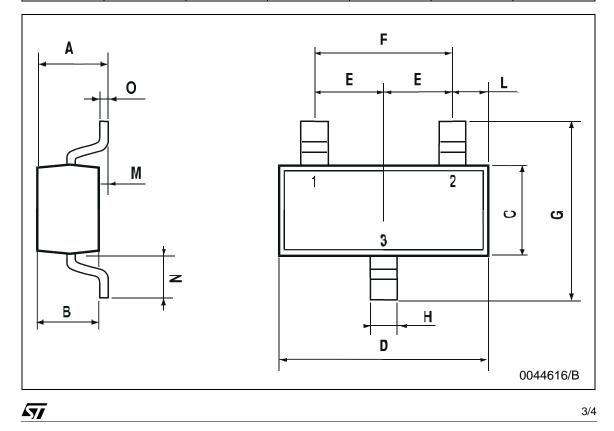
57

* Pulsed: Pulse duration = 300 $\mu s,$ duty cycle \leq 2 %

2/4

SUI-23 MECHANICAL DATA							
DIM.		mm			mils		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	0.85		1.1	33.4		43.3	
В	0.65		0.95	25.6		37.4	
С	1.20		1.4	47.2		55.1	
D	2.80		3	110.2		118	
E	0.95		1.05	37.4		41.3	
F	1.9		2.05	74.8		80.7	
G	2.1		2.5	82.6		98.4	
н	0.38		0.48	14.9		18.8	
L	0.3		0.6	11.8		23.6	
М	0		0.1	0		3.9	
Ν	0.3		0.65	11.8		25.6	
0	0.09		0.17	3.5		6.7	





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4/4

57